

PCN # 1360

DATE: November 8, 2013

EXPECTED PCN SHIP DATE: June 10, 2019



Quality Assurance  
160 Rio Robles  
San Jose, CA 95134

www.maximintegrated.com

PROCESS CHANGE NOTICE  
 PRODUCT CHANGE NOTICE

MAXIM INTEGRATED HEREBY ISSUES NOTIFICATION OF CHANGE  
THAT MAY AFFECT THE FOLLOWING CATEGORIES:

DESIGN     WAFER FAB     ASSEMBLY     TEST     ELEC/MECH SPECS

AFFECTED PRODUCT:

Ordering P/N: (See PN listing XLS in PCN ZIP file)

CHANGE FROM: OY77-1 die type fabricated at Maxim's San Jose California X3 fab.

CHANGE TO: OY99 die type fabricated at Maxim's Partner fab, Epson in Sakata Japan.

JUSTIFICATION: OY77-1 contains additional disconnected circuitry not required in MAX44246. OY99 eliminates this circuitry, allowing a much smaller die size to be used for the MAX44246. There is not change to the form, fit or function of the device.

TRACEABILITY: Maxim Integrated maintains full traceability by device marking, packaging labels and shipment documents.

Maxim Integrated's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

*Nasser Ali Chaouche*

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

Contact your local Maxim Integrated Company Representative    or    Nasser AliChaouche, PCN Coordinator  
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